NSN 5962-01-324-2470

Memory Microcircuit - Page 1 of 2



View Online at https://aerobasegroup.com/nsn/5962-01-324-2470

Body Length: 1.280 inches **Body Width:** Between 0.220 inches and 0.310 inches **Body Height:** Between 0.140 inches and 0.185 inches **Maximum Power Dissipation Rating:** 1.2 watts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Hermetically sealed and burn in and programmable and monolithic **Inclosure Material:** Ceramic **Inclosure Configuration:** Dual-in-line **Output Logic Form:** Transistor-transistor logic **Input Circuit Pattern:** 20 input **Case Outline Source And Designator:** D-9 mil-m-38510 **Current Rating Per Characteristic:** 100.00 milliamperes output sink **Terminal Surface Treatment:** Solder **Product Name:** 20-input 8-output registered and-or gate array Voltage Rating And Type Per Characteristic: 12.0 volts power source **Time Rating Per Chacteristic:** 45.00 nanoseconds propagation delay time, low to high level output and 45.00 nanoseconds propagation delay time, high to low level output Memory Device Type: Pal **Test Data Document:** 96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.). **Terminal Type And Quantity:**

24 printed circuit

Shelf Life:

N/a

NSN 5962-01-324-2470

Memory Microcircuit - Page 2 of 2

Unit Of Measure:

Demilitarization:

No

Fiig:

A458a0

